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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Yves LE DU et al..

Examiner: M. Jackson

Serial No.: 09/821,796

Group Art Unit: 1773

Filed: March 30, 2001

RECEIVED  
APR 10 2003  
GROUP 1700

Title: STRUCTURE COMPRISING A BINDER LAYER NON-DELAMINABLE WITH  
RESPECT TO A METALLIZED SUBSTRATE AND PEELABLE WITH  
RESPECT TO A POLYPROPYLENE SUBSTRATE

AMENDMENT AND REPLY

Assistant Commissioner for Patents  
Washington, D.C. 20231

Sir:

In response to the Office Action dated October 4, 2002, please amend the above-  
referenced application as indicated below and consider the remarks which follow:

IN THE CLAIMS:

Please amend claims 16, 18, 20-27, 29, and 33-35 as follows:

16. (Amended) A multilayer structure comprising a metal layer or a metallized-  
substrate layer (5) and a binder layer (6) comprising polypropylene, extrusion-coated at a rate of  
more than 100 m/min. onto the metal or metallized-substrate layer, said layers (6, 5) being made non-  
delaminable by heat treating the said structure to a temperature above the melting point of the binder